| ASSOCIATION CONNECTING<br>ASSOCIATION CONNECTING<br>LECTRONICS INDUSTRIES | IPC. Bannockl | ourn, Illinois, A    | ll rights reserved untions. | under both              | This docume<br>level parts, t                                       | ent is a declaration entities the declaration entities and the declaration entities and the declaration entities and the declaration entities are an | on of the su                             | bstances v<br>s all lower | vithin the manufactu<br>level materials for v | urer listed which the | item. Note:<br>manufacture      | if the item is an as<br>er has engineering | sembly with low responsibility. |  |
|---|---------------|----------------------|-----------------------------|-------------------------|---|--|--|---------------------------|---|-----------------------|---------------------------------|--|---------------------------------|--|
|   |               |                      |                             | Form Type<br>Distribute | * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materia |  |  |                           |   | rials and N           | als and Mfg Information         |  |                                 |  |
| Supplier Information  |               |                      |                             |                         |   |  |  |                           |   |                       |                                 |  |                                 |  |
| Company name* Con   |               |                      | Company unique ID           |                         |   | Unique ID Authority  |  |                           |   |                       | Response Date*                  |  |                                 |  |
| nsemi   |               |                      |                             |                         |   |  |  | 2024-05-17                |   |                       |                                 |  |                                 |  |
| ontact Name Title - Contact   |               |                      | et                          |                         | Phone - Contact*  |  |  |                           | Email   | Email - Contact*      |                                 |  |                                 |  |
| Product-Env-Stewards Product Envi   |               |                      | viro Compliance             |                         |   | NA   |  |                           |   | Produ                 | Product-Env-Stewards@onsemi.com |  |                                 |  |
| Authorized Representative* Title - Repres                                 |               |                      | esentative                  |                         |   | Phone - Representative*  |  |                           |   | Email                 | Email - Representative*         |  |                                 |  |
| Product-Env-Stewards Pro  |               |                      | Product Enviro Compliance   |                         |   | NA   |  |                           |   | Produ                 | Product-Env-Stewards@onsemi.com |  |                                 |  |
| Requester Item Number   | Mfr Iten      | n Number             | Mfr Item Name               |                         |   | Effective Date   | Version                                  | М                         | Manufacturing Site                            |                       | Weight*                         | UOM  | Unit Type                       |  |
|   | BSS138        | BLT3G NFET SOT23 50V |                             | V 200MA 3.50            |   | 2024-05-17   |  | C                         | CN1   |                       | 8.02                            | mg   | Each                            |  |
| Ianufacturing Proccess Informa  | ntion         |                      |                             |                         |   |  |  | ·                         |   |                       |                                 |  |                                 |  |
| Terminal Plating / Grid Array M   | laterial 7    | Terminal Base Alloy  |                             | J-STD-020 MSI           | Rating  | Peak Proce   | Process Body Temperature Max Time at Pea |                           | k Tempera                                     | ature Num             | nber of Reflow Cyc              | eles                                       |                                 |  |
| Matte Tin (Sn) - annealed CU Allo   |               | CU Alloy             | 1                           |                         |   | <b>260</b> C   |  | С                         | 30 seco                                       |                       | seconds 3                       |  |                                 |  |
| omments   |               |                      |                             |                         |   |  |  |                           |   |                       |                                 |  |                                 |  |
| vel 1 - maximum time at peak temperat                                     | ure during so | ldering is 10-3      | 0 seconds                   |                         |   |  |  |                           |   |                       |                                 |  |                                 |  |
| or more information regarding materia                                     | l composition | please refer to      | page 3                      |                         |   |  |  |                           |   |                       |                                 |  |                                 |  |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|---|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the  | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and co<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa   | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per  | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |   |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester   | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska   | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance  | CAS         | Exempt | Weight | Unit of Measure |
|----------------------|--------|-----------------|----------|--|-------------|--------|--------|-----------------|
| Die                  | 0.05   | mg              | Supplier | Silicon (Si)   | 7440-21-3   |        | 0.05   | mg              |
| Lead Frame           | 2.92   | mg              | В        | Nickel (Ni)  | 7440-02-0   |        | 1.06   | mg              |
|                      |        |                 | Supplier | Iron (Fe)  | 7439-89-6   |        | 1.4658 | mg              |
|                      |        |                 | Supplier | Copper (Cu)  | 7440-50-8   |        | 0.3942 | mg              |
| Mold Compound-Black  | 4.9    | mg              | Supplier | Boron zinc hydroxide oxide                             | 138265-88-0 |        | 0.147  | mg              |
|                      |        |                 | Supplier | Zinc Monoxide (ZnO)                                    | 1314-13-2   |        | 0.0245 | mg              |
|                      |        |                 | Supplier | 2,4,6-triamino-s-triazincompd.withs-<br>triazine-triol | 37640-57-6  |        | 0.147  | mg              |
|                      |        |                 | Supplier | Silica Amorphous (SiO2)                                | 7631-86-9   |        | 3.92   | mg              |
|                      |        |                 | Supplier | Carbon Black (C)                                       | 1333-86-4   |        | 0.049  | mg              |
|                      |        |                 | Supplier | Ortho-Cresol Novolac Resin                             | 29690-82-2  |        | 0.392  | mg              |
|                      |        |                 | Supplier | Phenolic Resin (Novolac)                               | 9003-35-4   |        | 0.2205 | mg              |
| Plating              | 0.14   | mg              | Supplier | Tin (Sn)   | 7440-31-5   |        | 0.14   | mg              |
| Wire Bond - Cu       | 0.01   | mg              | Supplier | Copper (Cu)  | 7440-50-8   |        | 0.01   | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted)